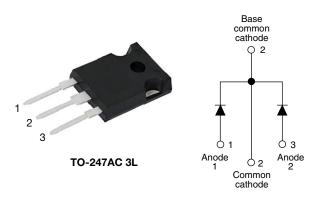
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High Performance Schottky Rectifier, 2 x 20 A



PRIMARY CHARACTERISTICS								
I _{F(AV)}	2 x 20 A							
V _R	15 V							
V _F at I _F	See Electrical table							
I _{RM} max.	600 mA at 100 °C							
T _J max.	125 °C							
E _{AS}	10 mJ							
Package	TO-247AC 3L							
Circuit configuration	Common cathode							

FEATURES

- 125 °C T_J operation ($V_R < 5 V$)
- · Optimized for OR-ing applications
- Ultra low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy **FREE** encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The VS-STPS40L15CW... center tap Schottky rectifier module has been optimized for ultra low forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	CHARACTERISTICS	VALUES	UNITS					
I _{F(AV)}	Rectangular waveform	40	А					
V _{RRM}		15	V					
I _{FSM}	t _p = 5 μs sine	700	А					
V _F	19 A_{pk} , T_J = 125 °C (per leg, typical)	0.25	V					
Тј		-55 to +125	°C					

VOLTAGE RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VS-STPS40L15CW-N3	UNITS			
Maximum DC reverse voltage	V _R	T₁ = 100 °C	15	V			
Maximum working peak reverse voltage	V _{RWM}	IJ= 100 C	15	v			

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDI	TEST CONDITIONS							
Maximum average forward per leg		50 % duty cycle at T _C = 86 °C	rootongular wavoform	20						
current, see fig. 5 per device	I _{F(AV)}	30% duty cycle at $10 = 60%$	40							
Maximum peak one cycle non-repetitive surge	1	5 μs sine or 3 μs rect. pulse	Following any rated load condition and	700	А					
current per leg, see fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	with rated V _{RRM}	330						
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 2 A, L = 5 m⊦	10	mJ						
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to ze Frequency limited by T _J maxim	2	А						

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COMPLIANT

HALOGEN



VS-STPS40L15CW-N3



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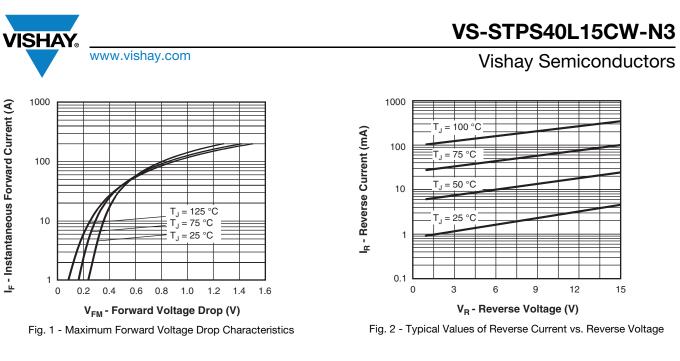
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ELECTRICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CO	TYP.	MAX.	UNITS					
		19 A	T ₁ = 25 °C	-	0.41					
Maximum forward voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	40 A	1j=25 0	-	0.52	v				
	V FM (1)	19 A	T, = 125 °C	0.25	0.33					
		40 A	1j=125 C	0.37	0.50					
Reverse leakage current per leg	I _{BM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	-	10	mA				
See fig. 2	IRM \''	T _J = 100 °C	VR - Haleu VR	-	600	IIIA				
Threshold voltage	V _{F(TO)} 0.182		82	V						
Forward slope resistance	r _t	$T_J = T_J maximum$ 7.6		.6	mΩ					
Maximum junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal ran	-	2000	pF					
Typical series inductance per leg	L _S	Measured lead to lead 5 r	8	-	nH					
Maximum voltage rate of change	dV/dt	Rated V _R	10	000	V/µs					

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Maximum junction temperature range	TJ		- 55 to 125	°C						
Maximum storage temperature range	T _{Stg}		- 55 to 150							
Maximum thermal resistance, junction to case per leg	P	DC operation See fig. 4	1.4							
Maximum thermal resistance, junction to case per package	- R _{thJC}	DC operation	0.7	°C/W						
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth and greased	0.24							
Approvimate weight			6	g						
Approximate weight			0.21	oz.						
Mounting torque		Non-lubricated threads	6 (5)	kgf ⋅ cm						
Mounting torque maximum]			(lbf · in)						
Marking device		Case style TO-247AC 3L	STPS40	L15CW						



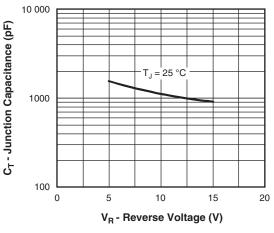


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

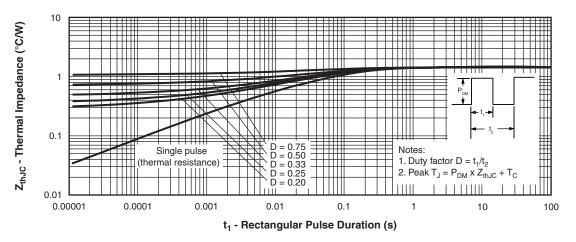
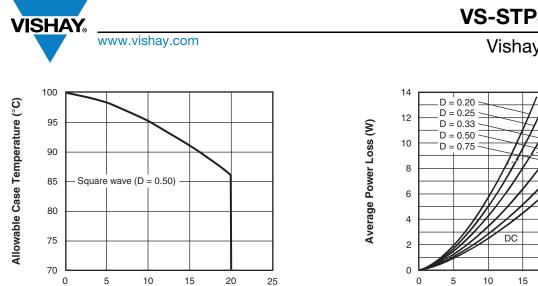
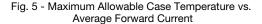
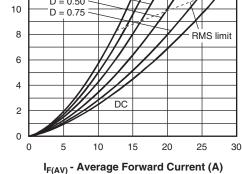


Fig. 4 - Maximum Thermal Impedance Zth,JC Characteristics











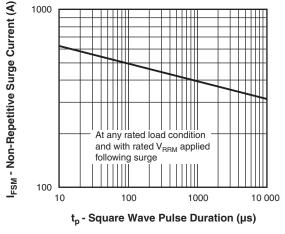


Fig. 7 - Maximum Non-Repetitive Surge Current

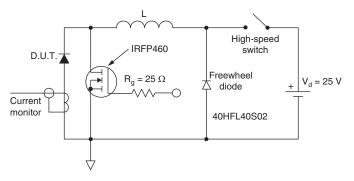


Fig. 8 - Unclamped Inductive Test Circuit

VS-STPS40L15CW-N3

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ORDERING INFORMATION TABLE

Device code	VS-	STPS	40	L	15	CW	-N3
		2	3	4	5	6	7
	1 2 3 4 5 6	- Sch - Cur - L = - Vol - Pac CW	nottky S rent rati low forv tage coo ckage: r = TO-2	niconduo TPS ser ngs (40 vard vol de (15 = '47 ntal digit	ies = 40 A) tage 15 V)		_
				gen-free		-complia	ant, and

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-STPS40L15CW-N3	25	500	Antistatic plastic tube						

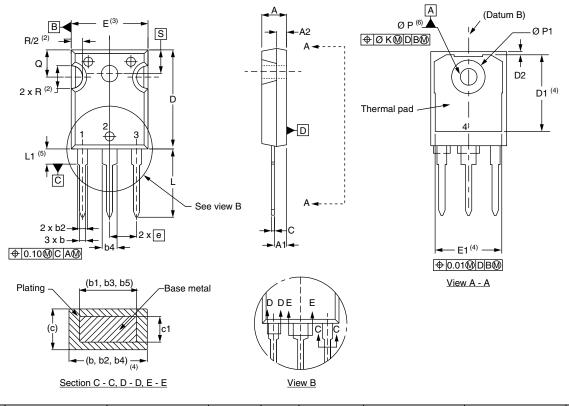
LINKS TO RELATED DOCUMENTS							
Dimensions www.vishay.com/doc?96138							
Part marking information	www.vishay.com/doc?95007						



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TO-247AC 3L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWDOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	5 BSC	
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			ØΡ	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133			Ø P1	-	7.39	-	0.291	
С	0.38	0.89	0.015	0.035			Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033			R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3		S	5.51	BSC	0.217	' BSC	
D1	13.08	-	0.515	-	4							

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

(4) Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension Q

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